## S/N 10/786,354



PATENT

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Kie Y. Ahn et al.

Examiner:

Andy Huynh

Serial No.:

10/786,354

Group Art Unit:

2818

Filed:

February 25, 2004

Docket:

303.686US3

Title:

MULTILEVEL COPPER INTERCONNECTS WITH LOW-K DIELECTRICS

AND AIR GAPS

## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(c)(2), Applicants request that the fee of \$180.00 as set forth in 37 C.F.R. §1.17(p) be charged to Deposit Account No. 19-0743.

Filing Date: February 25, 2004

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Pursuant to 37 C.F.R. 1.98(a)(2), Applicant believes that copies of cited U.S. Patents and Published Applications are no longer required to be provided to the Office. Notification of this change was provided in the United States Patent and Trademark Office OG Notices dated October 12, 2004. Thus, Applicant has not included copies of any US Patents or Published Applications cited with this submission. Should the Office require copies to be provided, Applicant respectfully requests that notice of such requirement be directed to Applicant's below-signed representative. Applicant acknowledges the requirement to submit copies of foreign patent documents and non-patent literature in accordance with 37 C.F.R. 1.98(a)(2).

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

KIE Y. AHN ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A. P.O. Box 2938
Minneapolis, MN 55402

(612) 349-9587

Date / / / //////

Timothy B Clise

Reg. No. 40,95

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this day of June, 2005.

Judy Dent

Name

Signature

PTO/SB/08A(10-01)
Approved for use through 10/31/2002, OMB 851-0031
US Palent & Trademark Office U.S. DEPARTMENT OF COMMERCE
Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number,
Complete if Known Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSURE 10/786,354 **Application Number** STATEMENT BY APPLICANT February 25, 2004 (Use as many sheets as nece **Filing Date** Ahn, Kie **First Named Inventor Group Art Unit** 2818 JUN 2 0 2005 **Examiner Name** Huynh, Andy Attorney Docket No: 303.686US3 Sheet 1 of 1

US PATENT DOCUMENTS							
Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Filing Date If Appropriate			
	US-5,953,626	09/14/1999	Hause, F. N., et al.	06/05/1996			
	US-6,342,722	01/29/2002	Armacost, M., et al.	08/05/1999			
	US-6,413,827	07/02/2002	Farrar, Paul A.	02/14/2000			
	US-6,633,074	10/14/2003	Ahn, K. Y.	06/03/1999			

FOREIGN PATENT DOCUMENTS								
Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	T²				

	OTHER DOCUMENTS NON PATENT LITERATURE DOCUMENTS						
Examiner Initials*	Cite No <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>2</sup>				

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JUN 2 0 2005 M

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Due Date: N/A

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#### MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

 $\underline{X}$  A return postcard.

- X A Supplemental Information Disclosure Statement (2 pgs.), and Form 1449 (1 pg.) Documents NOT enclosed.
- A check in the amount of \$180.00 to cover the fee for consideration of Information Disclosure Statement under 97(c).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

Atty: Timothy & Clis Reg. No. 40,957

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 100 day of June, 2005.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)



# Receipt is hereby acknowledged for the following in the United States Patent and Trademark Office:

In re Patent Application of: Kie Y. Ahn et al.

itle: MULTILEVEL COPPER INTERCONNECTS WITH LOW-K DIELECTRICS

AND AIR GAPS

Serial No.: 10/786,354 Filing Date: February 25, 2004

CONTENTS: An Supplemental Information Disclosure Statement (2 pgs.), Form 1449 (1 pg.), Return Postcard and Transmittal Sheet.

Mailed: June <u>//</u>, 2005 TBC/jld

Docket No.: 303.686US3

Due Date: N/A